



N-Channel 30-V (D-S) MOSFET



Pb-free
Available

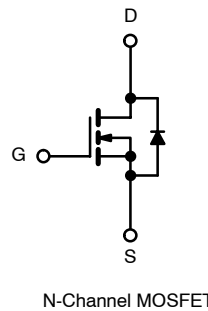
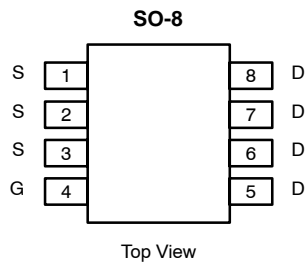
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.0135 @ $V_{GS} = 10$ V	10
	0.020 @ $V_{GS} = 4.5$ V	8

FEATURES

- TrenchFET® Power MOSFET
- 100% R_g Tested

APPLICATIONS

- Battery Switch
- Load Switch



Ordering Information: Si4410BDY
Si4410BDY—T1 (with Tape and Reel)
Si4410BDY—E3 (Lead (Pb)-Free)
Si4410BDY-T1—E3 (Lead (Pb)-Free with Tape and Reel)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)					
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage	V_{DS}	30		V	
Gate-Source Voltage	V_{GS}	± 20			
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	$T_A = 25^\circ\text{C}$	10	7.5	A
		$T_A = 70^\circ\text{C}$	8	6	
Pulsed Drain Current (10 μs Pulse Width)	I_{DM}	50			
Continuous Source Current (Diode Conduction) ^a	I_S	2.3	1.26	W	
Maximum Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	2.5		1.4
		$T_A = 70^\circ\text{C}$	1.6	0.9	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 10$ sec	40	50	$^\circ\text{C}/\text{W}$
		Steady State	70	90	
Maximum Junction-to-Foot (Drain)	R_{thJF}	25	30		

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)

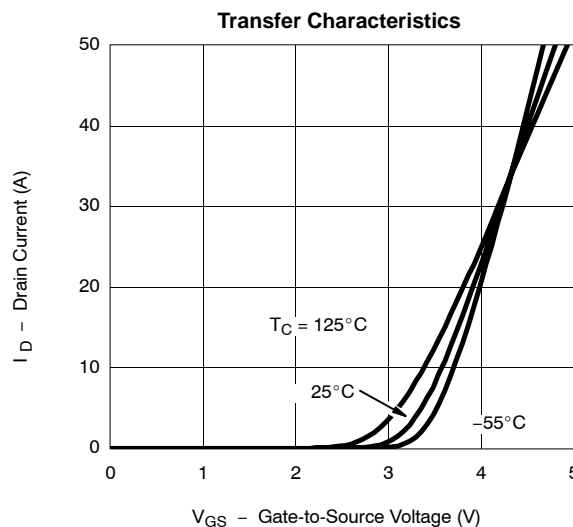
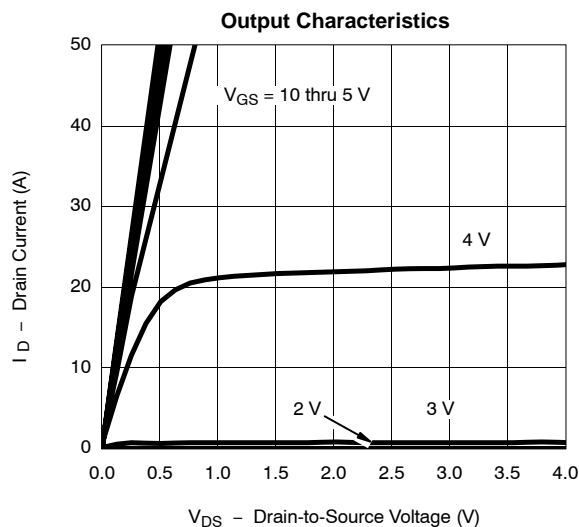
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.0		3.0	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	μA
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	20			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 10 A		0.011	0.0135	Ω
		V _{GS} = 4.5 V, I _D = 5 A		0.0165	0.020	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 10 A		25		S
Diode Forward Voltage ^a	V _{SD}	I _S = 2.3 A, V _{GS} = 0 V		0.76	1.1	V
Dynamic^b						
Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 5 V, I _D = 10 A		13	20	nC
Total Gate Charge	Q _{gt}	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		25	40	
Gate-Source Charge	Q _{gs}			5.5		
Gate-Drain Charge	Q _{gd}			3.7		
Gate Resistance	R _g	f = 1 MHz	0.5	1.6	2.7	Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = 25 V, R _L = 25 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _G = 6 Ω		10	15	ns
Rise Time	t _r			10	15	
Turn-Off Delay Time	t _{d(off)}			40	60	
Fall Time	t _f			15	25	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.3 A, di/dt = 100 A/μs		35	70	

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Guaranteed by design, not subject to production testing.

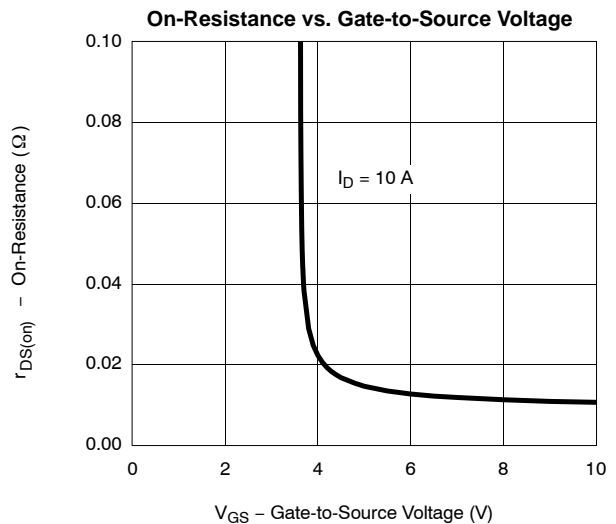
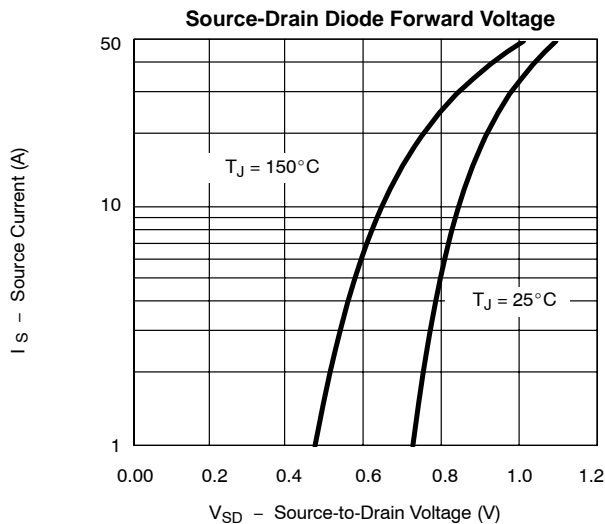
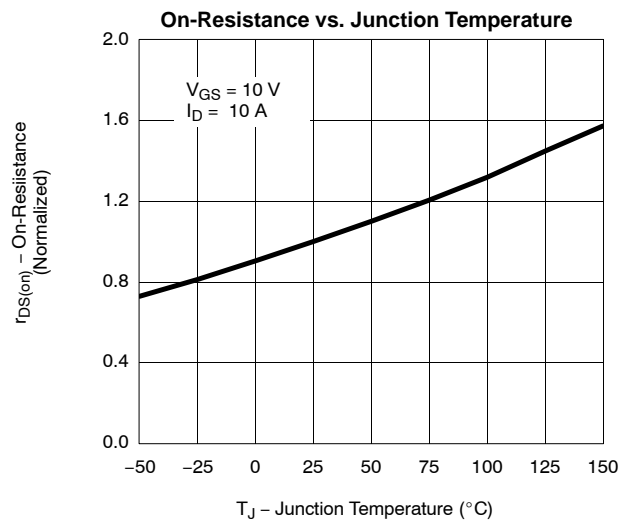
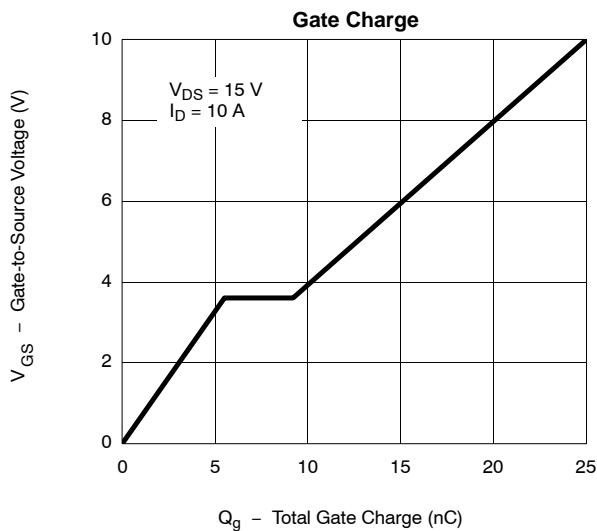
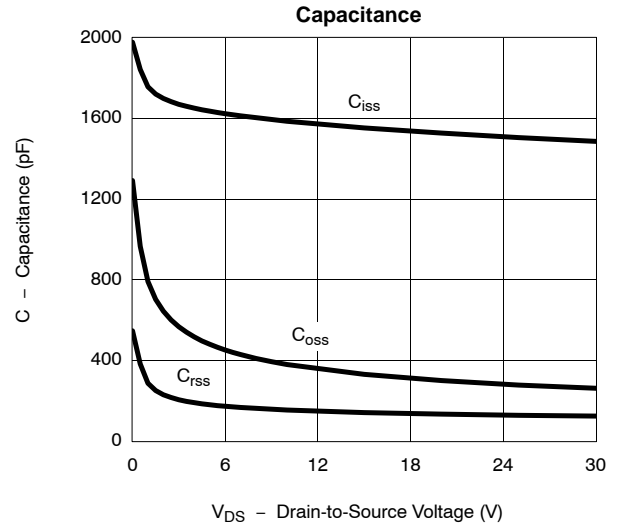
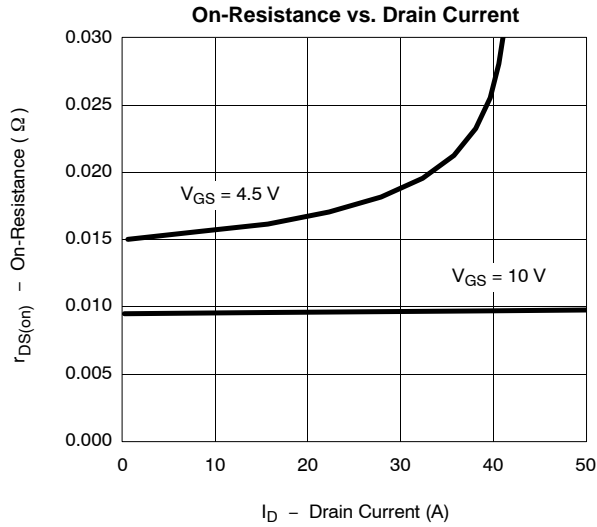
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

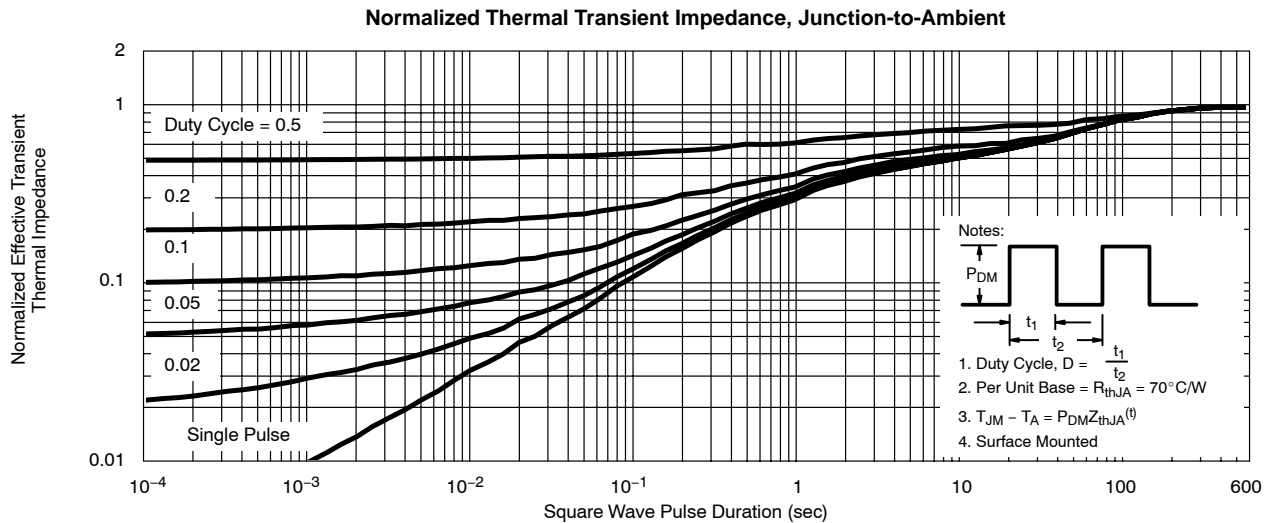
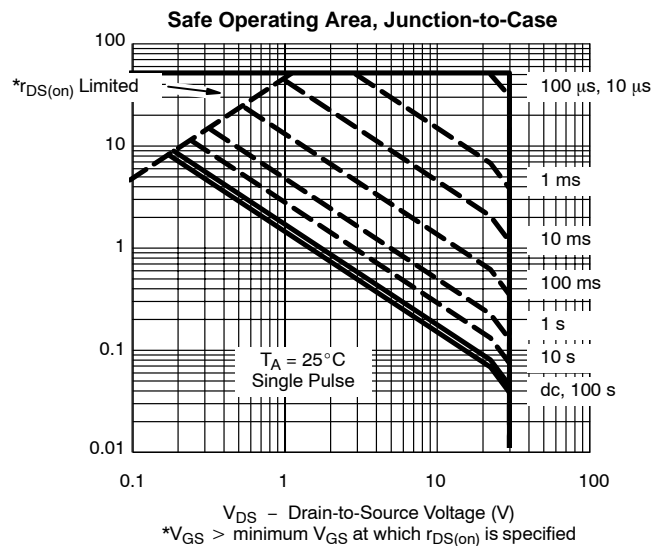
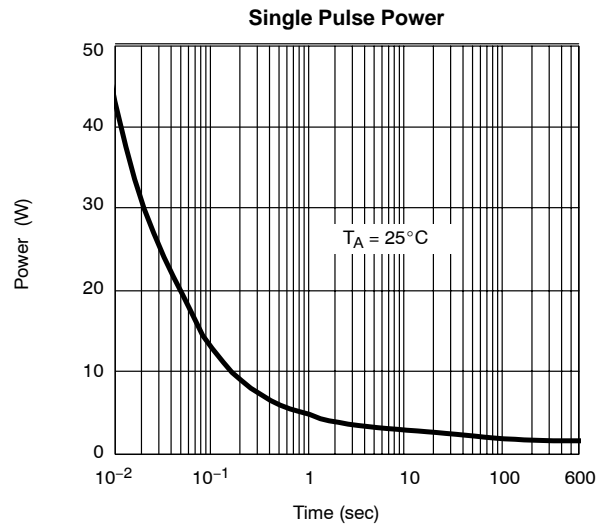
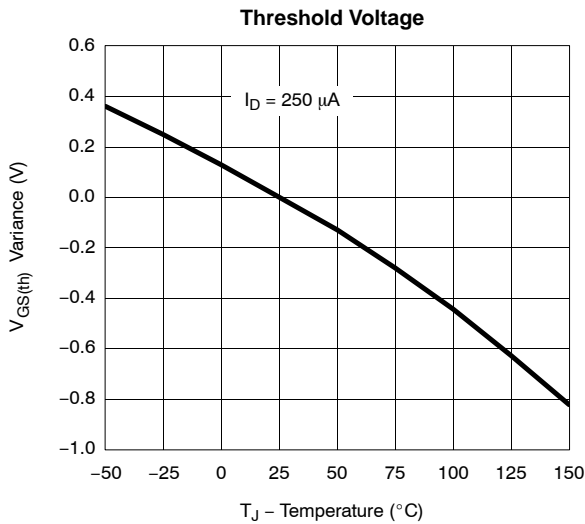




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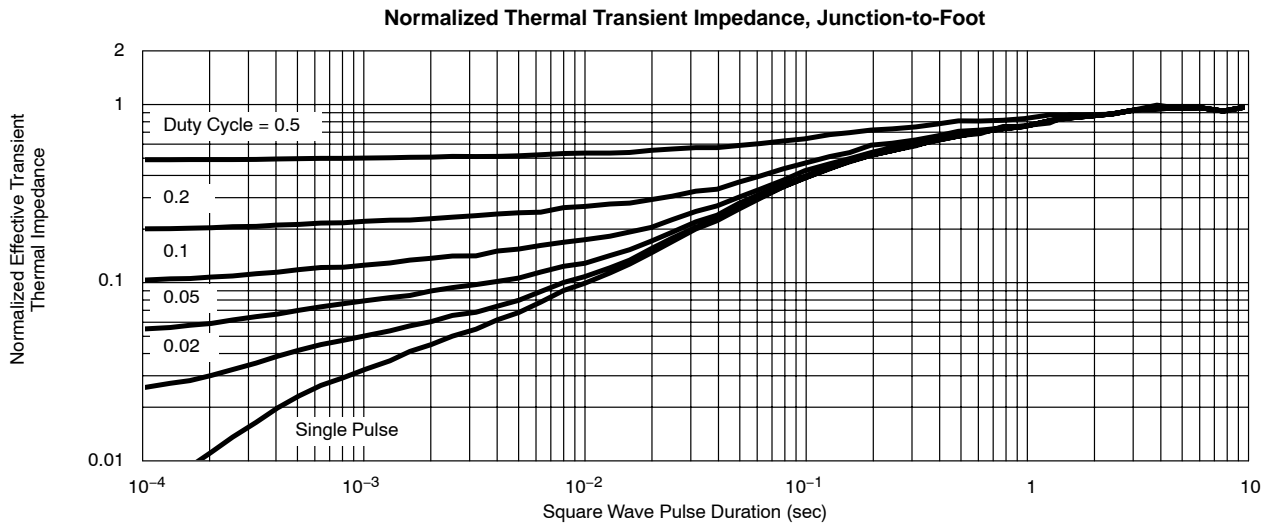


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